



# THE DATASHEET OF IKB40N65ES5ATMA1

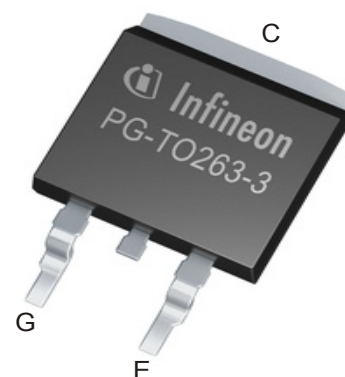
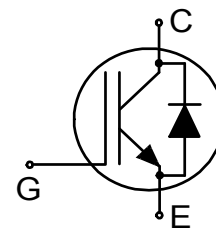


High speed switching series 5<sup>th</sup> generation

TRENCHSTOP™ 5 high speed soft switching IGBT copacked with full rated current RAPID 1 fast and soft anti parallel diode

**Features and Benefits:**

- High speed S5 technology offering
- High speed smooth switching device for hard & soft switching
  - Very Low  $V_{CEsat}$ , 1.35V at nominal current
  - 650V breakdown voltage
  - Low  $Q_G$
  - IGBT copacked with full rated current RAPID 1 fast antiparallel diode
  - Maximum junction temperature 175°C
  - Pb-free lead plating; RoHS compliant
  - Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>



**Potential Applications:**

- Energy Generation
  - Solar String Inverter
  - Solar Micro Inverter
- Industrial Power Supplies
  - Industrial SMPS
  - Industrial UPS
- Metal Treatment
  - Welding
- Energy Distribution
  - Energy Storage
- Infrastructure – Charge
  - Charger

**Product Validation:**

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



**Key Performance and Package Parameters**

Type	$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^{\circ}C$	$T_{vjmax}$	Marking	Package
IKB40N65ES5	650V	40A	1.35V	175°C	K40EES5	PG-TO263-3

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## High speed switching series 5<sup>th</sup> generation

### Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25^{\circ}\text{C}$	$V_{CE}$	650	V
DC collector current, limited by $T_{vjmax}$ $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$	$I_C$	79.0 50.0	A
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$	160.0	A
Turn off safe operating area $V_{CE} \leq 650\text{V}$ , $T_{vj} \leq 175^{\circ}\text{C}$ , $t_p = 1\mu\text{s}$	-	160.0	A
Diode forward current, limited by $T_{vjmax}$ <sup>1)</sup> $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$	$I_F$	40.0 40.0	A
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpuls}$	160.0	A
Gate-emitter voltage Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )	$V_{GE}$	$\pm 20$ $\pm 30$	V
Power dissipation $T_c = 25^{\circ}\text{C}$ Power dissipation $T_c = 100^{\circ}\text{C}$	$P_{tot}$	230.0 115.0	W
Operating junction temperature	$T_{vj}$	-40...+175	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-55...+150	$^{\circ}\text{C}$
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STA-020)		260	$^{\circ}\text{C}$

### Thermal Resistance

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>R<sub>th</sub> Characteristics</b>						
IGBT thermal resistance, junction - case	$R_{th(j-c)}$		-	-	0.65	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		-	-	0.75	K/W
Thermal resistance, min. footprint junction - ambient	$R_{th(j-a)}$		-	-	65	K/W
Thermal resistance, 6cm <sup>2</sup> Cu on PCB junction - ambient	$R_{th(j-a)}$		-	-	40	K/W

<sup>1)</sup> value limited by bondwire

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**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0\text{V}, I_C = 0.20\text{mA}$	650	-	-	V
Collector-emitter saturation voltage	$V_{CESat}$	$V_{GE} = 15.0\text{V}, I_C = 40.0\text{A}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	-	1.35	1.70	V
			-	1.50	-	
			-	1.60	-	
Diode forward voltage	$V_F$	$V_{GE} = 0\text{V}, I_F = 40.0\text{A}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	-	1.45	1.70	V
			-	1.42	-	
			-	1.39	-	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C = 0.40\text{mA}, V_{CE} = V_{GE}$	3.2	4.0	4.8	V
Zero gate voltage collector current	$I_{CES}$	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	-	-	50	$\mu\text{A}$
			-	2000	-	
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE} = 20\text{V}, I_C = 40.0\text{A}$	-	45.0	-	S

**Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{ies}$	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	-	2500	-	pF
Output capacitance	$C_{oes}$		-	71	-	
Reverse transfer capacitance	$C_{res}$		-	9	-	
Gate charge	$Q_G$	$V_{CC} = 520\text{V}, I_C = 40.0\text{A},$ $V_{GE} = 15\text{V}$	-	95.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	7.0	-	nH

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

**IGBT Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$**

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 25^{\circ}\text{C},$ $V_{CC} = 400\text{V}, I_C = 40.0\text{A},$ $V_{GE} = 0.0/15.0\text{V},$ $R_{G(on)} = 10.0\Omega, R_{G(off)} = 10.0\Omega,$ $L_{\sigma} = 30\text{nH}, C_{\sigma} = 30\text{pF}$ $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	19	-	ns
Rise time	$t_r$		-	18	-	ns
Turn-off delay time	$t_{d(off)}$		-	130	-	ns
Fall time	$t_f$		-	23	-	ns
Turn-on energy	$E_{on}$		-	0.86	-	mJ
Turn-off energy	$E_{off}$		-	0.40	-	mJ
Total switching energy	$E_{ts}$	-	1.26	-	mJ	

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Turn-on delay time	$t_{d(on)}$	$T_{vj} = 25^{\circ}C,$ $V_{CC} = 400V, I_C = 20.0A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 10.0\Omega, R_{G(off)} = 10.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	18	-	ns
Rise time	$t_r$		-	7	-	ns
Turn-off delay time	$t_{d(off)}$		-	143	-	ns
Fall time	$t_f$		-	24	-	ns
Turn-on energy	$E_{on}$		-	0.39	-	mJ
Turn-off energy	$E_{off}$		-	0.21	-	mJ
Total switching energy	$E_{ts}$		-	0.60	-	mJ

**Diode Characteristic, at  $T_{vj} = 25^{\circ}C$**

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^{\circ}C,$ $V_R = 400V,$ $I_F = 40.0A,$ $di_F/dt = 820A/\mu s$	-	73	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.10	-	$\mu C$
Diode peak reverse recovery current	$I_{rrm}$		-	23.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-1500	-	A/ $\mu s$

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^{\circ}C,$ $V_R = 400V,$ $I_F = 20.0A,$ $di_F/dt = 750A/\mu s$	-	58	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.80	-	$\mu C$
Diode peak reverse recovery current	$I_{rrm}$		-	22.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-1740	-	A/ $\mu s$

**Switching Characteristic, Inductive Load**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

**IGBT Characteristic, at  $T_{vj} = 150^{\circ}C$**

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^{\circ}C,$ $V_{CC} = 400V, I_C = 40.0A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 10.0\Omega, R_{G(off)} = 10.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	20	-	ns
Rise time	$t_r$		-	16	-	ns
Turn-off delay time	$t_{d(off)}$		-	156	-	ns
Fall time	$t_f$		-	48	-	ns
Turn-on energy	$E_{on}$		-	1.20	-	mJ
Turn-off energy	$E_{off}$		-	0.69	-	mJ
Total switching energy	$E_{ts}$		-	1.89	-	mJ

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^{\circ}C,$ $V_{CC} = 400V, I_C = 20.0A,$ $V_{GE} = 0.0/15.0V,$ $R_{G(on)} = 10.0\Omega, R_{G(off)} = 10.0\Omega,$ $L\sigma = 30nH, C\sigma = 30pF$ $L\sigma, C\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	18	-	ns
Rise time	$t_r$		-	8	-	ns
Turn-off delay time	$t_{d(off)}$		-	184	-	ns
Fall time	$t_f$		-	48	-	ns
Turn-on energy	$E_{on}$		-	0.60	-	mJ
Turn-off energy	$E_{off}$		-	0.39	-	mJ
Total switching energy	$E_{ts}$		-	0.99	-	mJ

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### Diode Characteristic, at $T_{vj} = 150^{\circ}\text{C}$

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^{\circ}\text{C},$ $V_R = 400\text{V},$ $I_F = 40.0\text{A},$ $di_F/dt = 820\text{A}/\mu\text{s}$	-	120	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	2.60	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	36.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-1250	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^{\circ}\text{C},$ $V_R = 400\text{V},$ $I_F = 20.0\text{A},$ $di_F/dt = 750\text{A}/\mu\text{s}$	-	91	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.80	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	32.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-1350	-	$\text{A}/\mu\text{s}$

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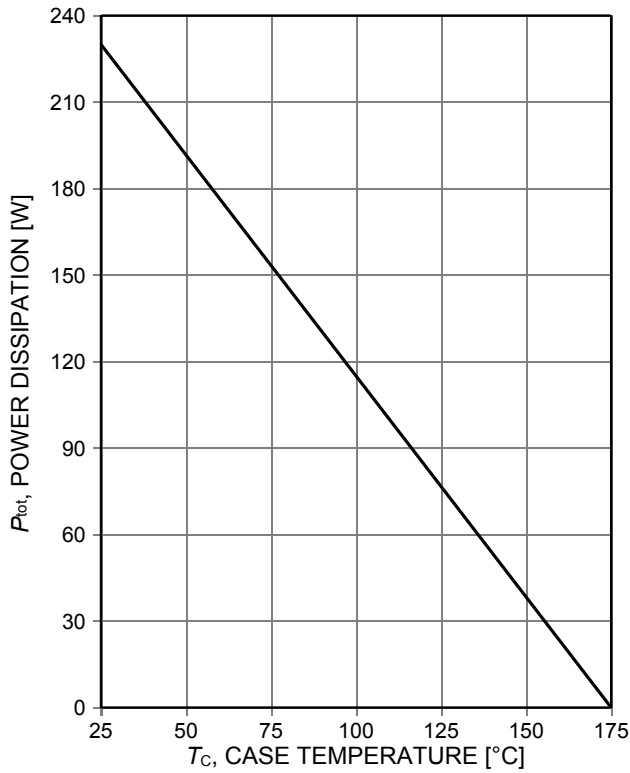


Figure 1. Power dissipation as a function of case temperature ( $T_{vj} \leq 175^{\circ}\text{C}$ )

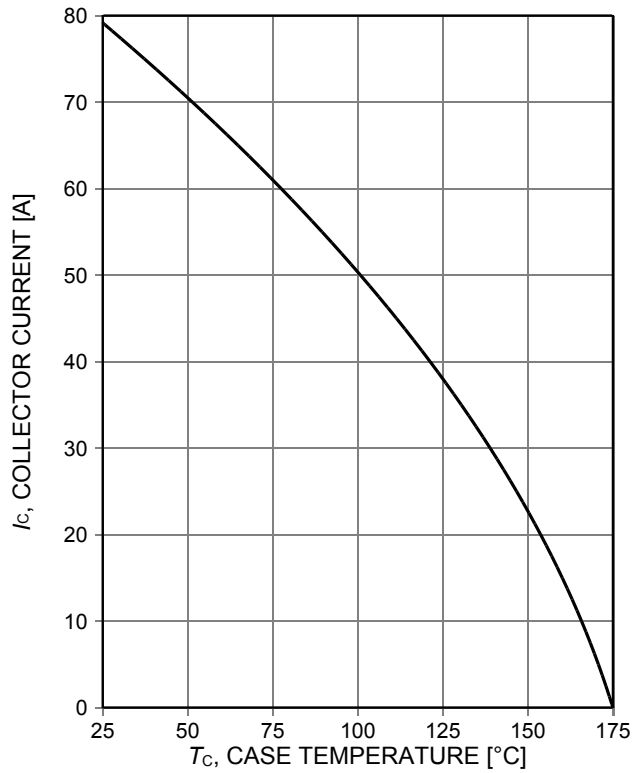


Figure 2. Collector current as a function of case temperature ( $V_{GE} \geq 15\text{V}$ ,  $T_{vj} \leq 175^{\circ}\text{C}$ )

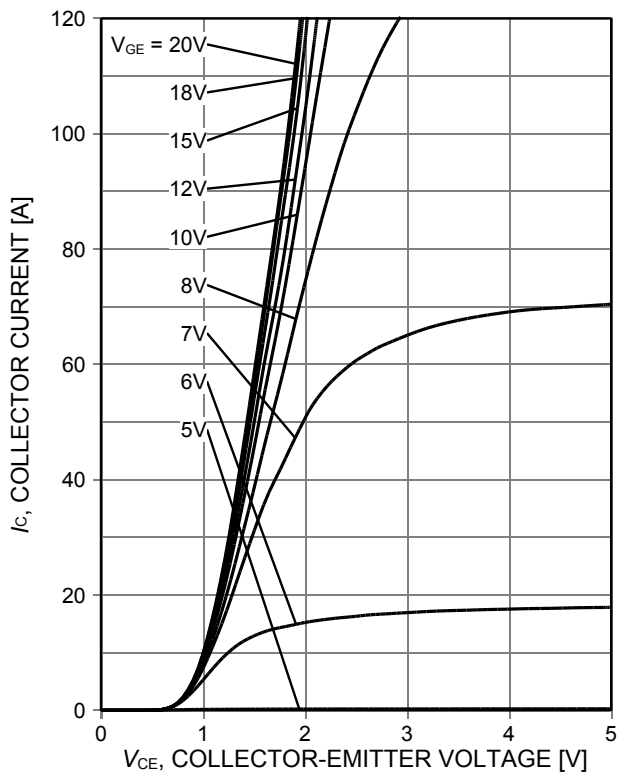


Figure 3. Typical output characteristic ( $T_{vj} = 25^{\circ}\text{C}$ )

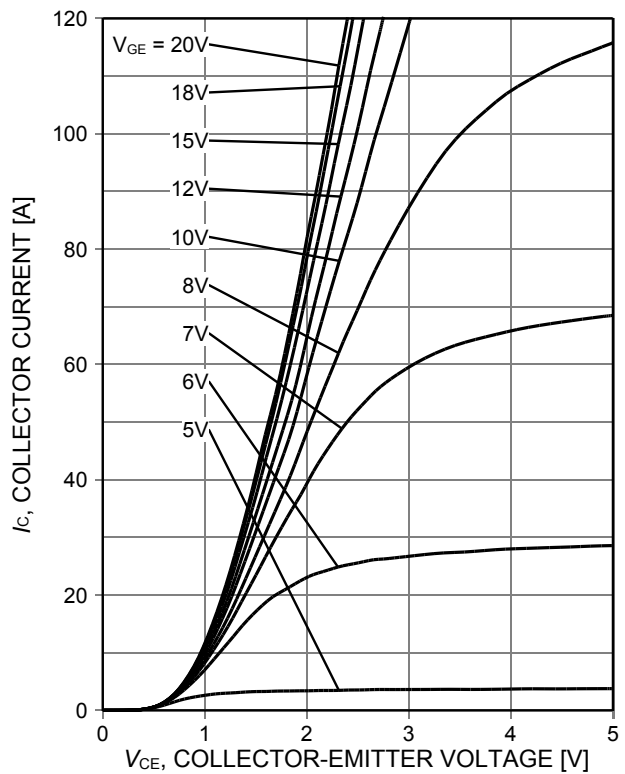


Figure 4. Typical output characteristic ( $T_{vj} = 150^{\circ}\text{C}$ )

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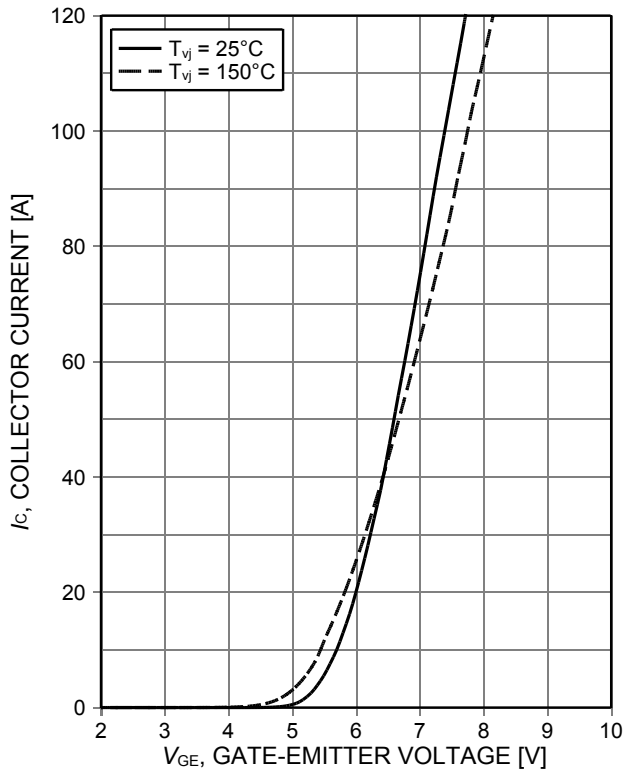


Figure 5. **Typical transfer characteristic**  
( $V_{CE}=20V$ )

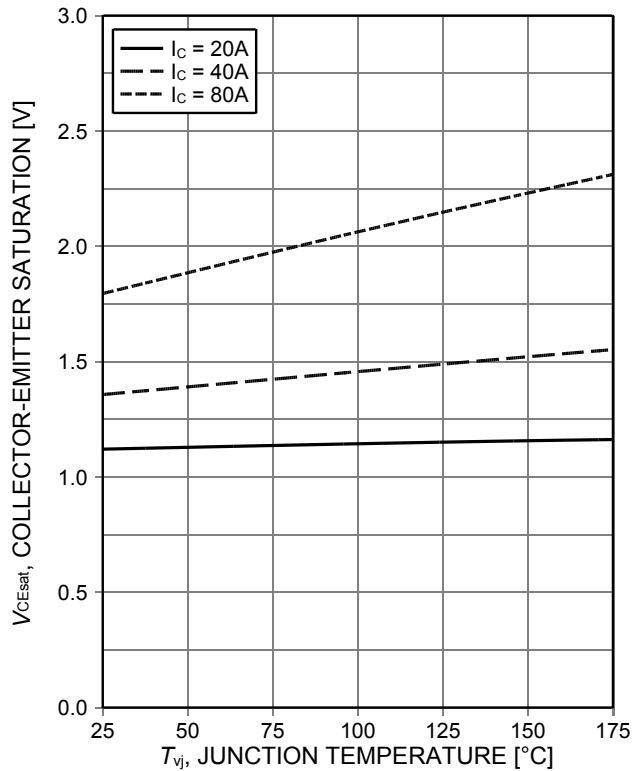


Figure 6. **Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE}=15V$ )

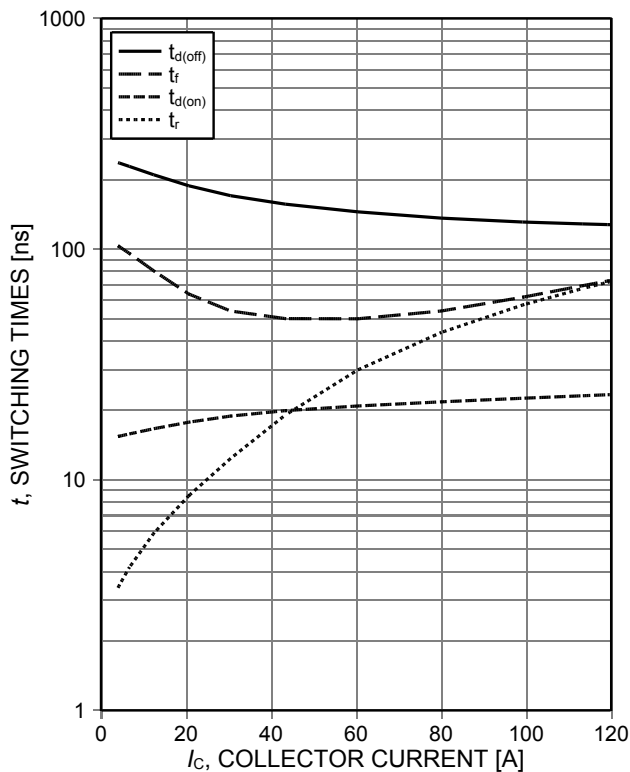


Figure 7. **Typical switching times as a function of collector current**  
(inductive load,  $T_{vj}=150^{\circ}C$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $R_{Gon}=10\Omega$ ,  $R_{Goff}=10\Omega$ , dynamic test circuit in Figure E)

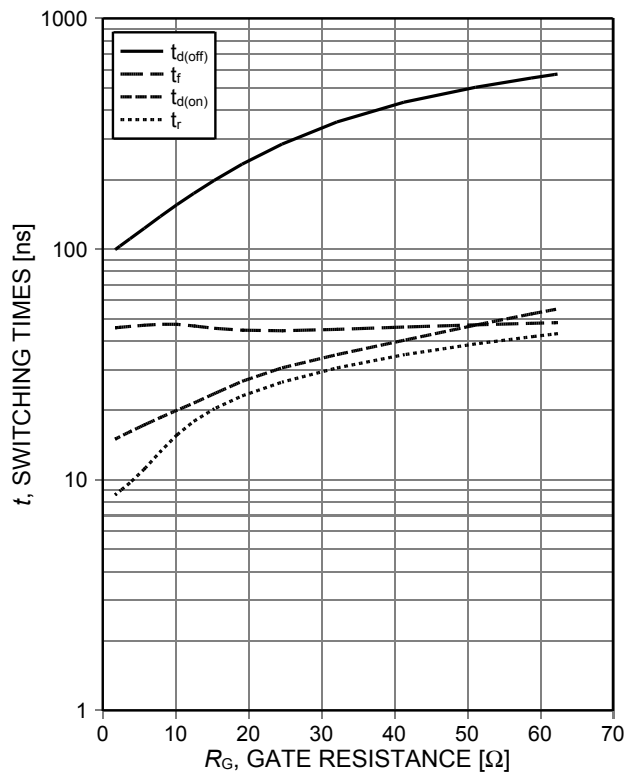


Figure 8. **Typical switching times as a function of gate resistance**  
(inductive load,  $T_{vj}=150^{\circ}C$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=40A$ , dynamic test circuit in Figure E)

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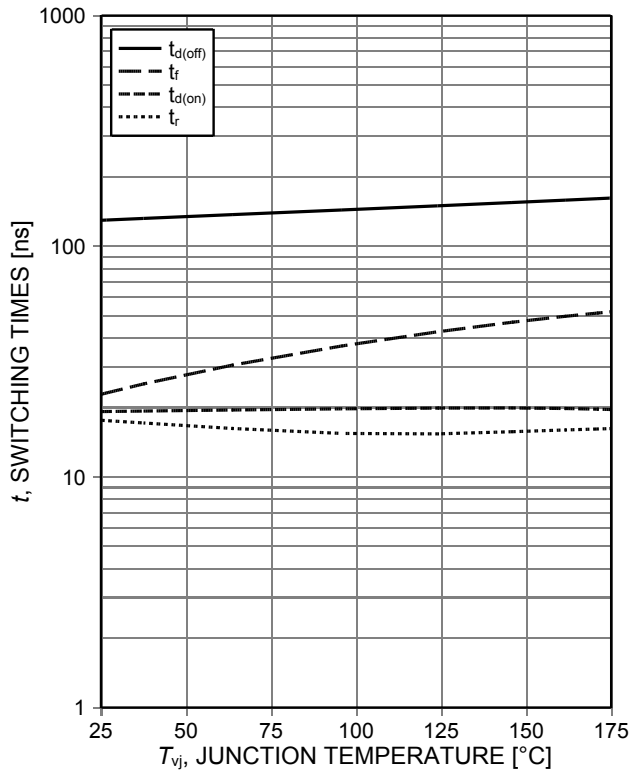


Figure 9. **Typical switching times as a function of junction temperature**  
 (inductive load,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=40A$ ,  $R_{Gon}=10\Omega$ ,  $R_{Goff}=10\Omega$ , dynamic test circuit in Figure E)

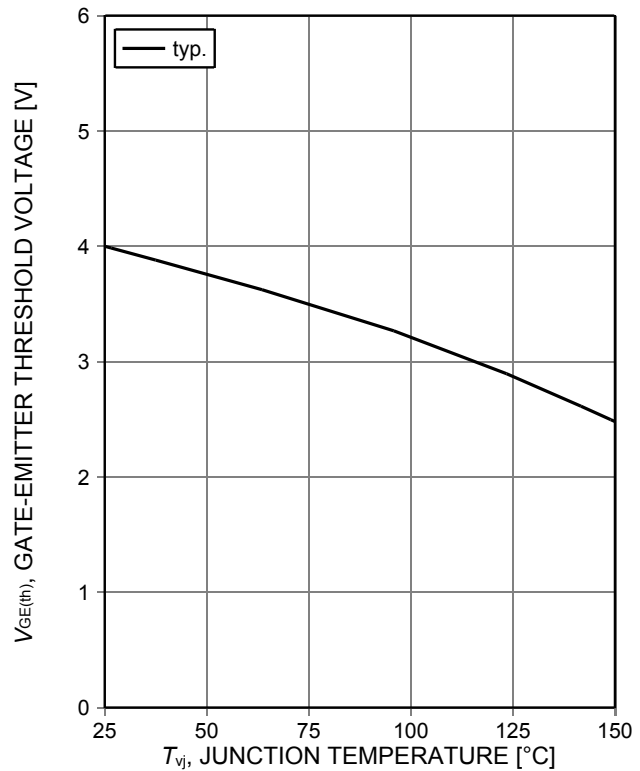


Figure 10. **Gate-emitter threshold voltage as a function of junction temperature**  
 ( $I_C=0.4mA$ )

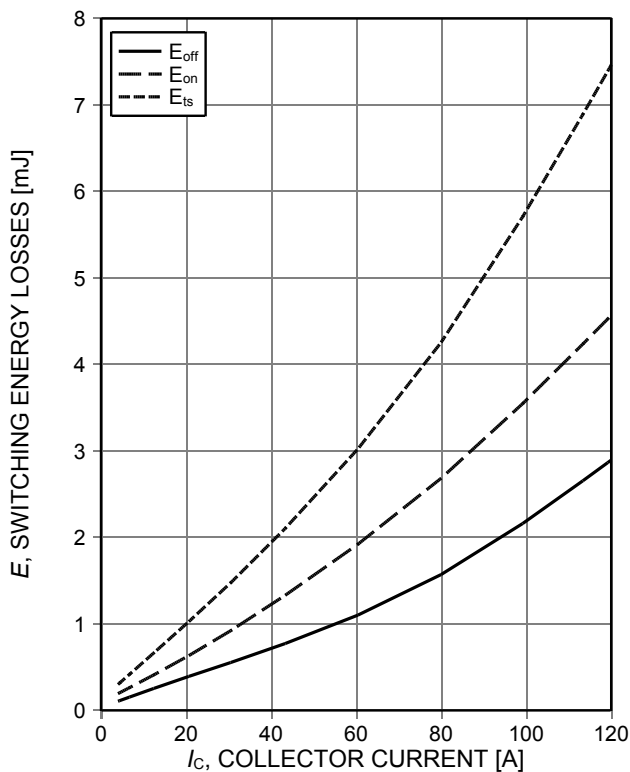


Figure 11. **Typical switching energy losses as a function of collector current**  
 (inductive load,  $T_{vj}=150^\circ C$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $R_{Gon}=10\Omega$ ,  $R_{Goff}=10\Omega$ , dynamic test circuit in Figure E)

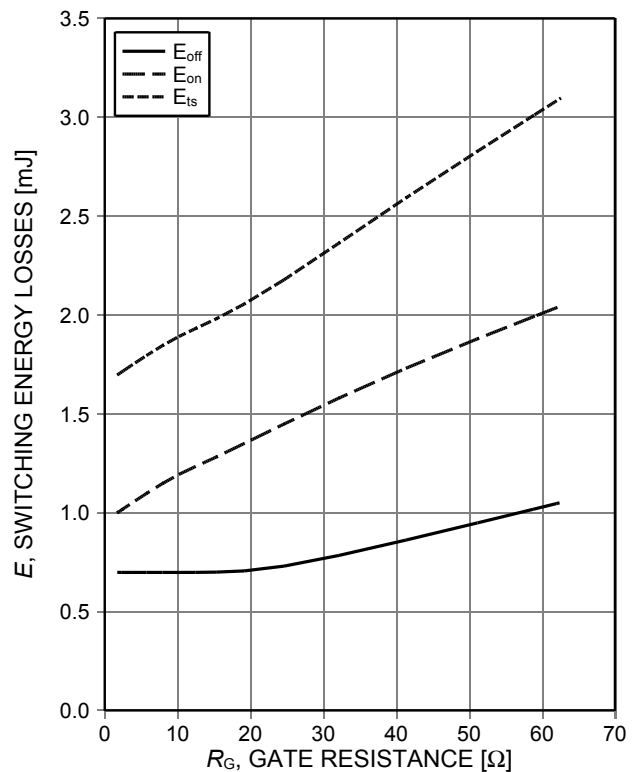


Figure 12. **Typical switching energy losses as a function of gate resistance**  
 (inductive load,  $T_{vj}=150^\circ C$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=40A$ , dynamic test circuit in Figure E)

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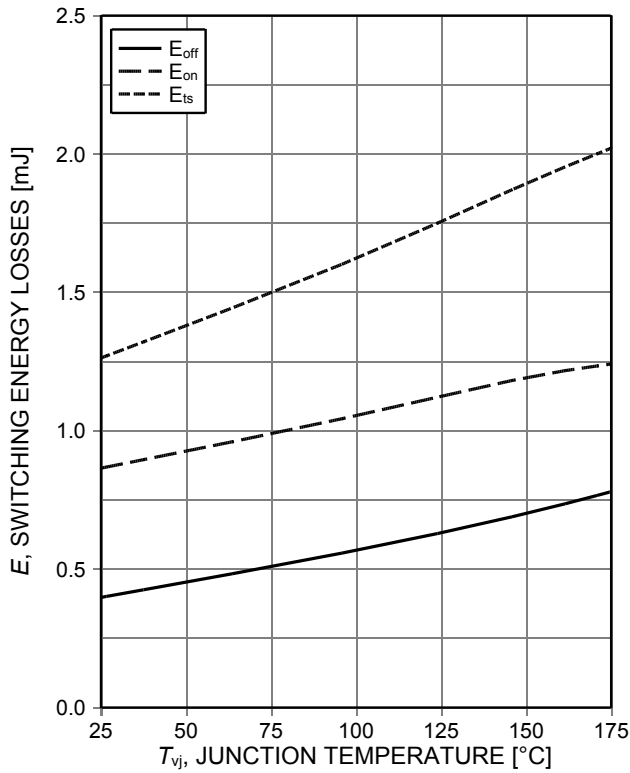


Figure 13. **Typical switching energy losses as a function of junction temperature** (inductive load,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=40A$ ,  $R_{Gon}=10\Omega$ ,  $R_{Goff}=10\Omega$ , dynamic test circuit in Figure E)

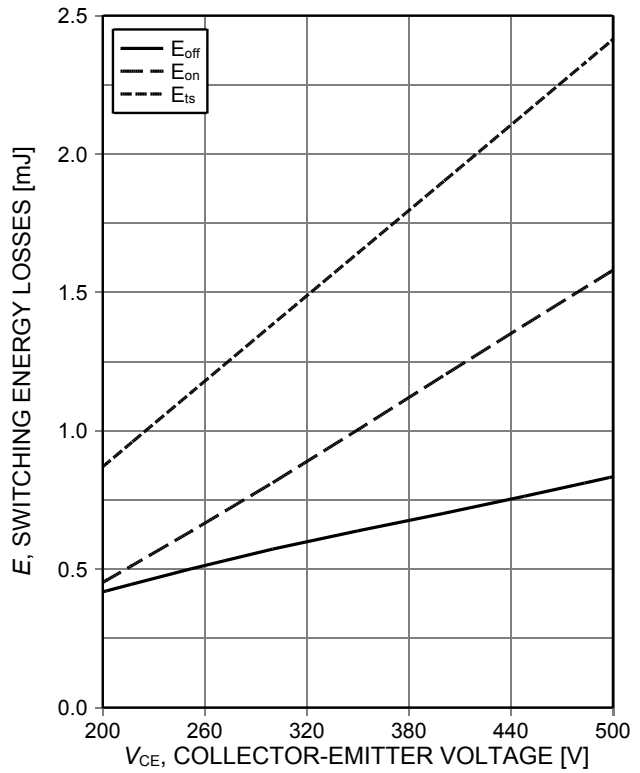


Figure 14. **Typical switching energy losses as a function of collector emitter voltage** (inductive load,  $T_{vj}=150^\circ C$ ,  $V_{GE}=0/15V$ ,  $I_C=40A$ ,  $R_{Gon}=10\Omega$ ,  $R_{Goff}=10\Omega$ , dynamic test circuit in Figure E)

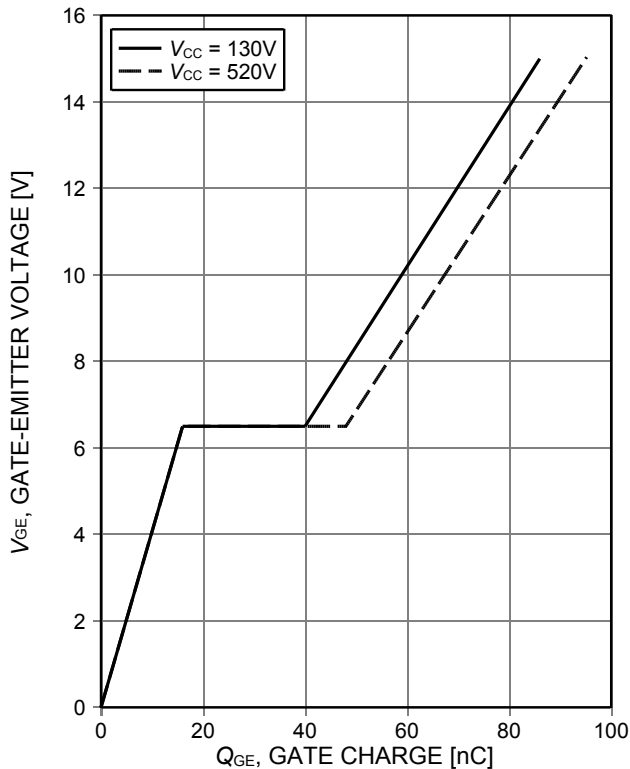


Figure 15. **Typical gate charge** ( $I_C=40A$ )

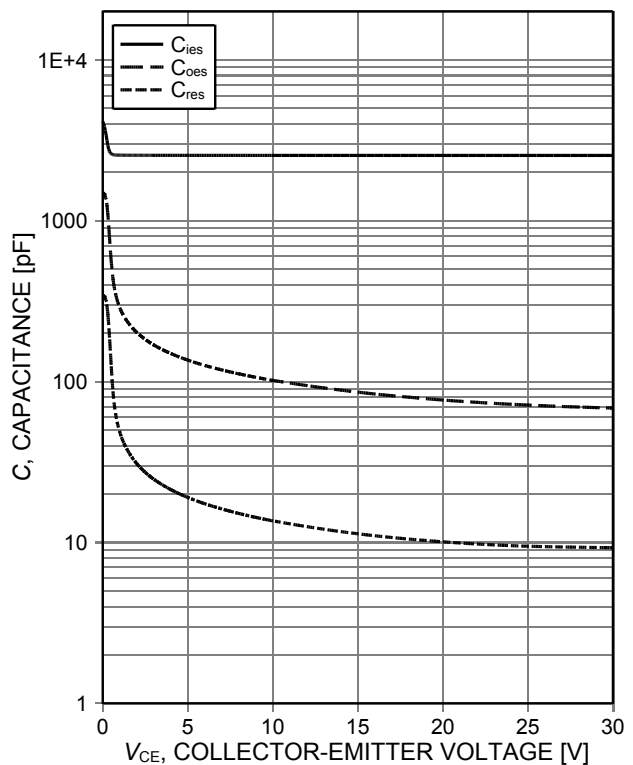


Figure 16. **Typical capacitance as a function of collector-emitter voltage** ( $V_{GE}=0V$ ,  $f=1MHz$ )

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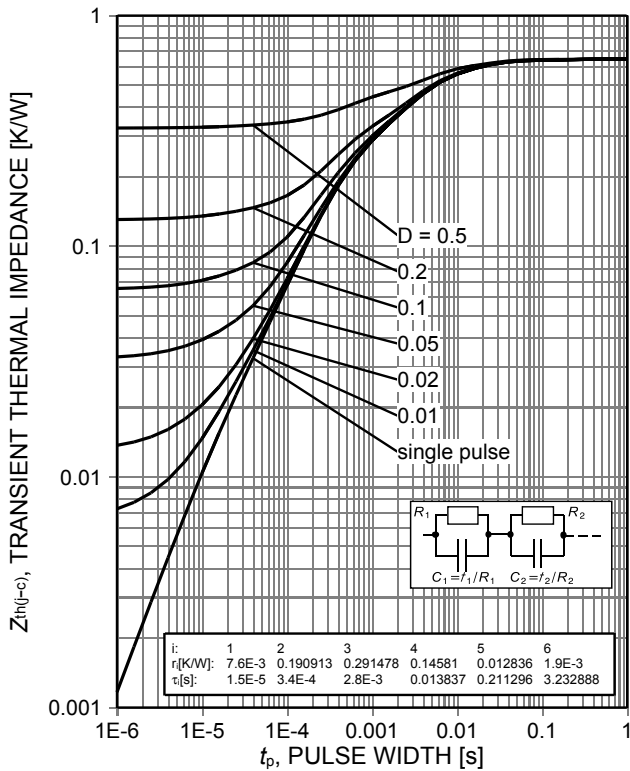


Figure 17. IGBT transient thermal impedance ( $D=t_p/T$ )

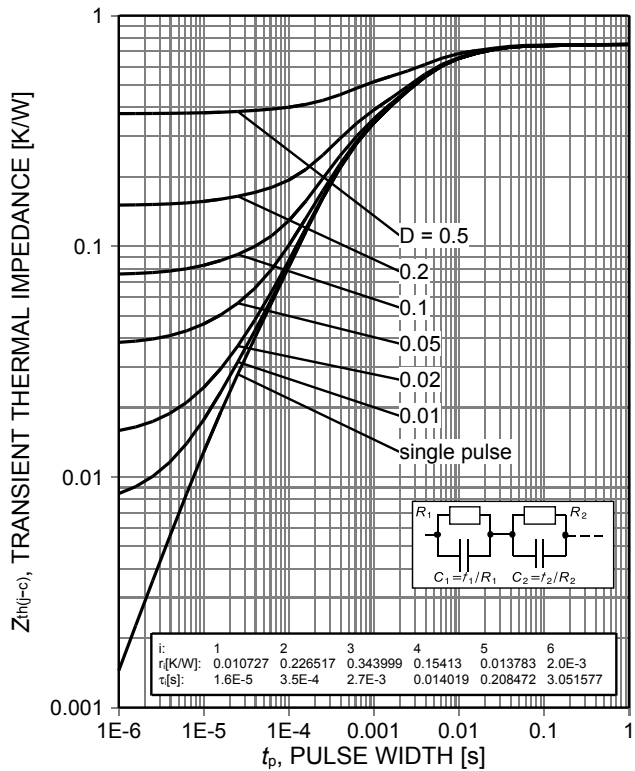


Figure 18. Diode transient thermal impedance as a function of pulse width ( $D=t_p/T$ )

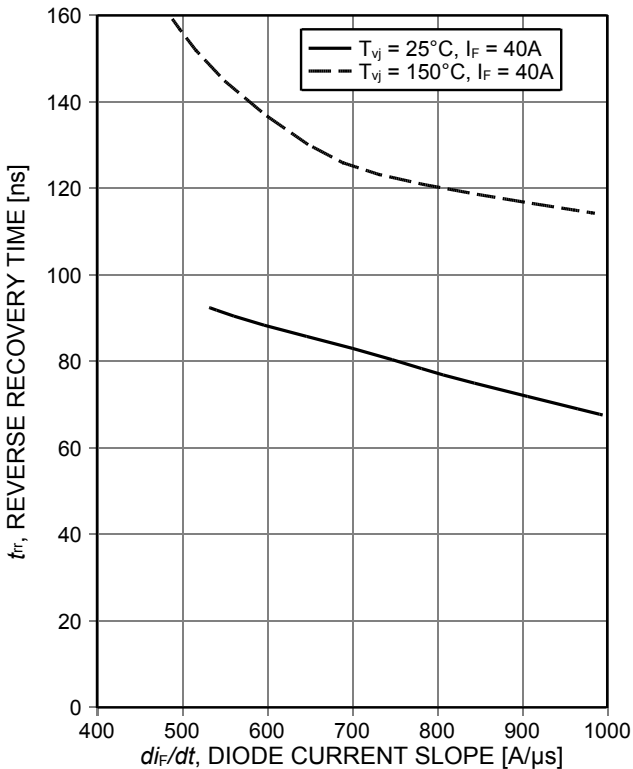


Figure 19. Typical reverse recovery time as a function of diode current slope ( $V_R=400V$ )

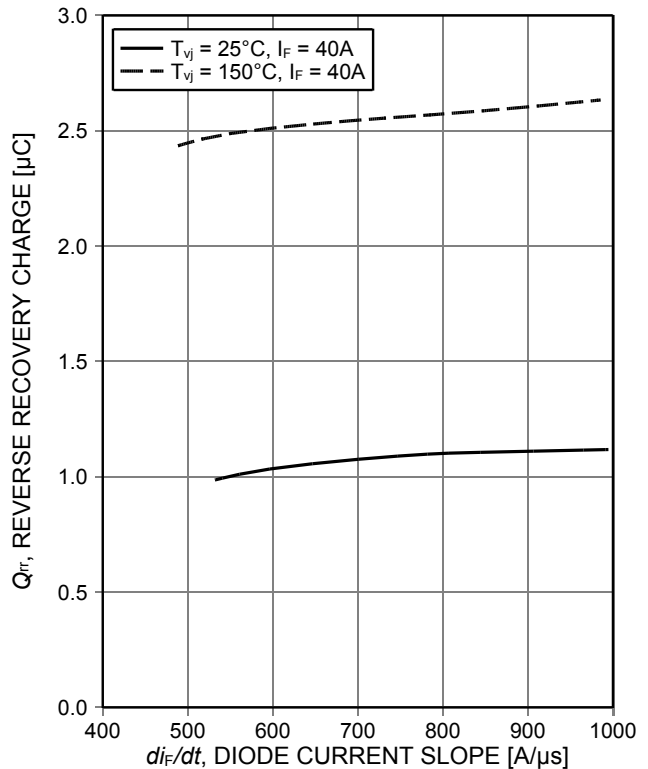


Figure 20. Typical reverse recovery charge as a function of diode current slope ( $V_R=400V$ )

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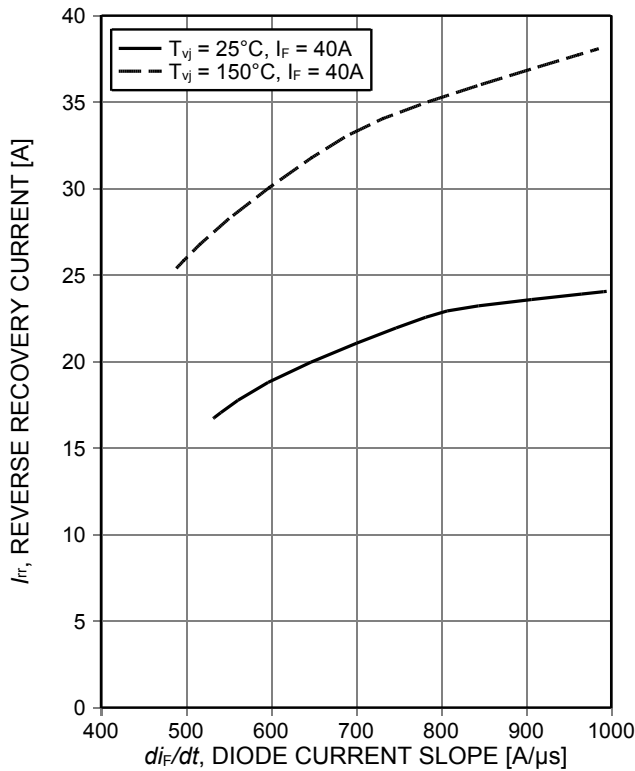


Figure 21. Typical reverse recovery current as a function of diode current slope ( $V_R=400V$ )

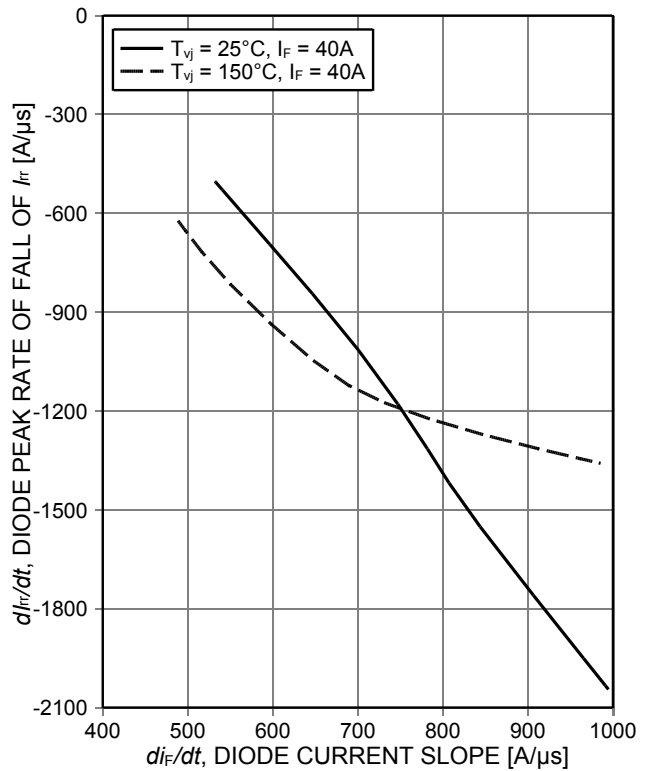


Figure 22. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R=400V$ )

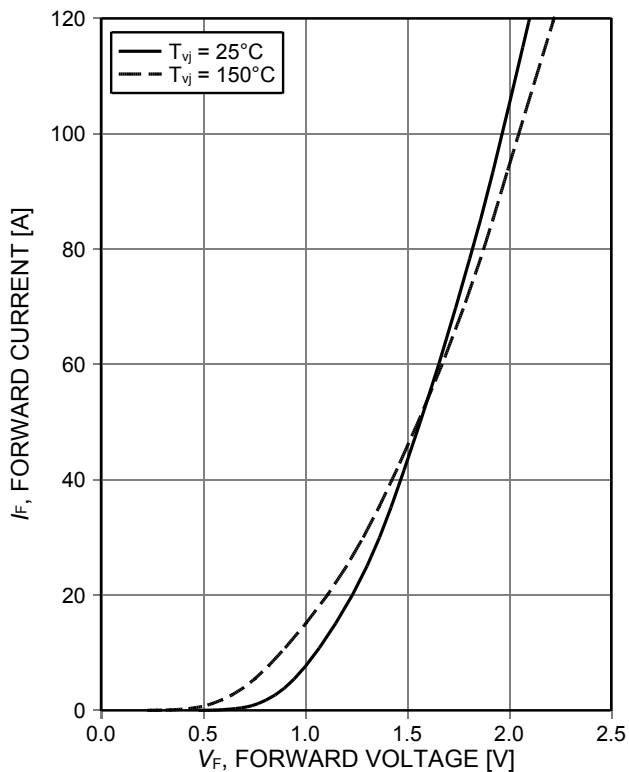


Figure 23. Typical diode forward current as a function of forward voltage

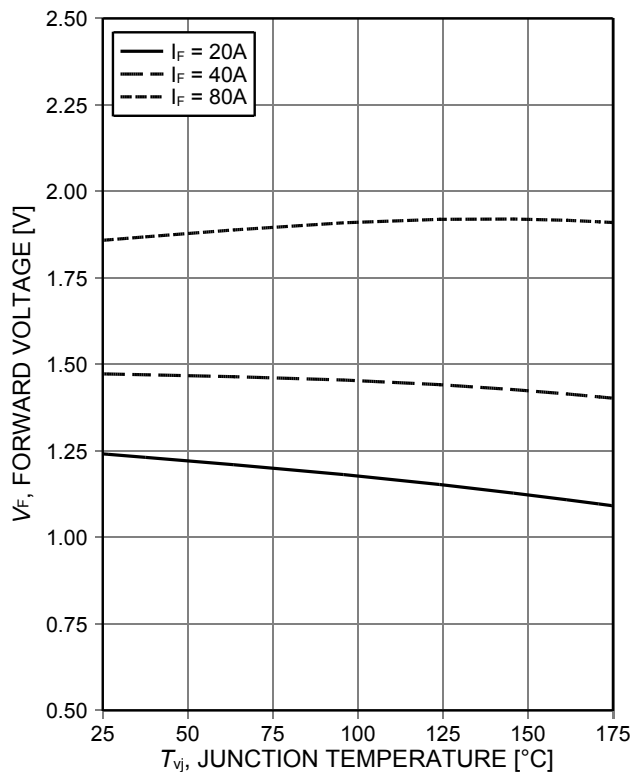
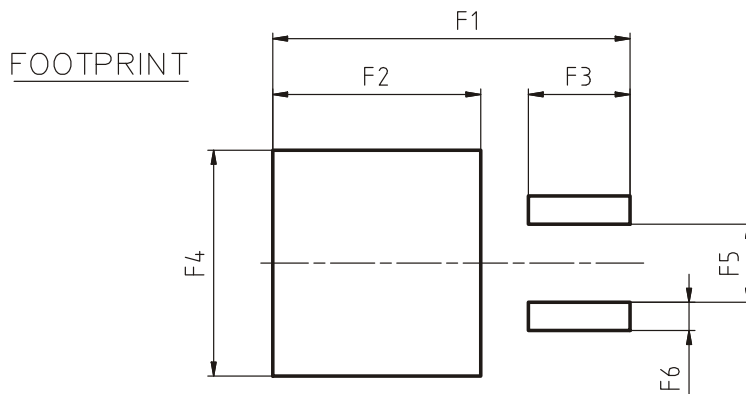
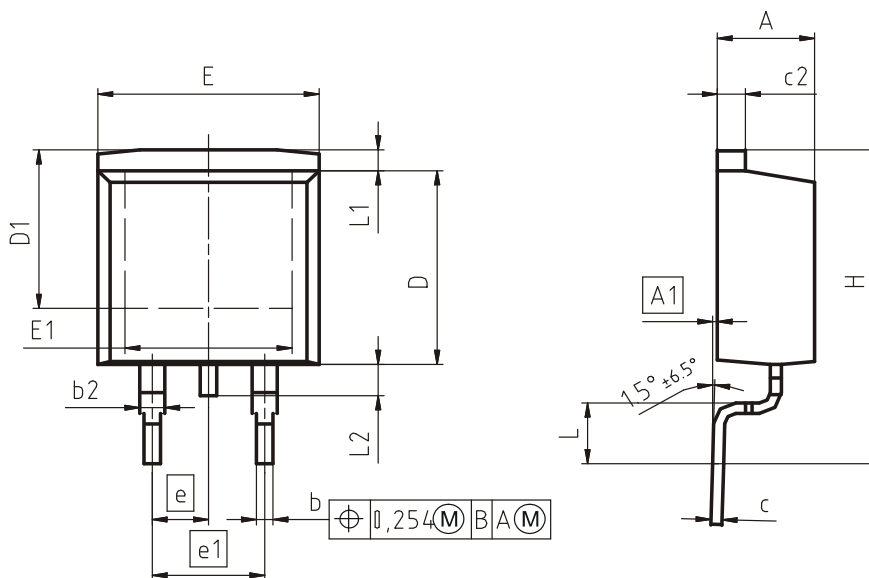


Figure 24. Typical diode forward voltage as a function of junction temperature

Package Drawing PG-TO263-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	0.00	0.25	0.000	0.010
b	0.65	0.85	0.026	0.033
b2	0.95	1.15	0.037	0.045
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.51	9.45	0.335	0.372
D1	7.10	7.90	0.280	0.311
E	9.80	10.31	0.386	0.406
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	2		2	
H	14.61	15.88	0.575	0.625
L	2.29	3.00	0.090	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
F1	16.05	16.25	0.632	0.640
F2	9.30	9.50	0.366	0.374
F3	4.50	4.70	0.177	0.185
F4	10.70	10.90	0.421	0.429
F5	3.65	3.85	0.144	0.152
F6	1.25	1.45	0.049	0.057

DOCUMENT NO.  
Z8B00003324

SCALE

7.5mm

EUROPEAN PROJECTION

ISSUE DATE  
30-08-2007

REVISION  
01

Testing Conditions

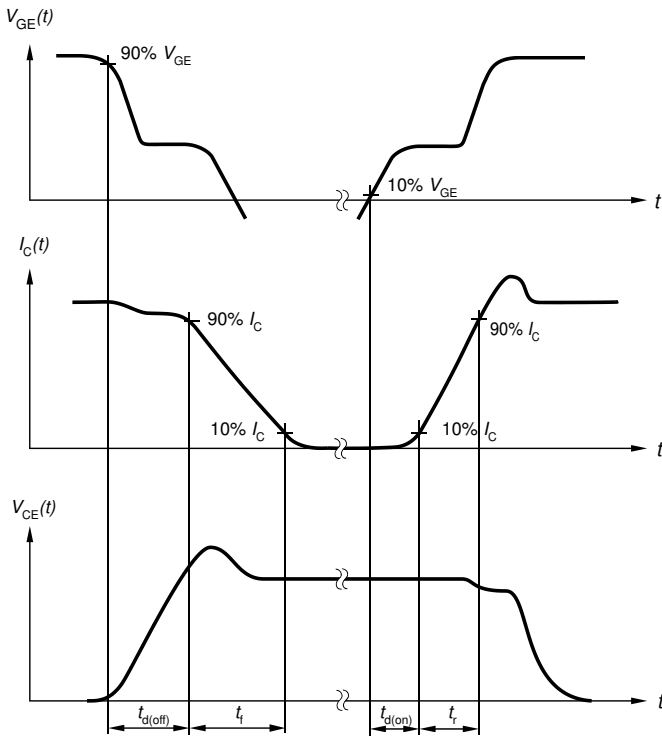


Figure A. Definition of switching times

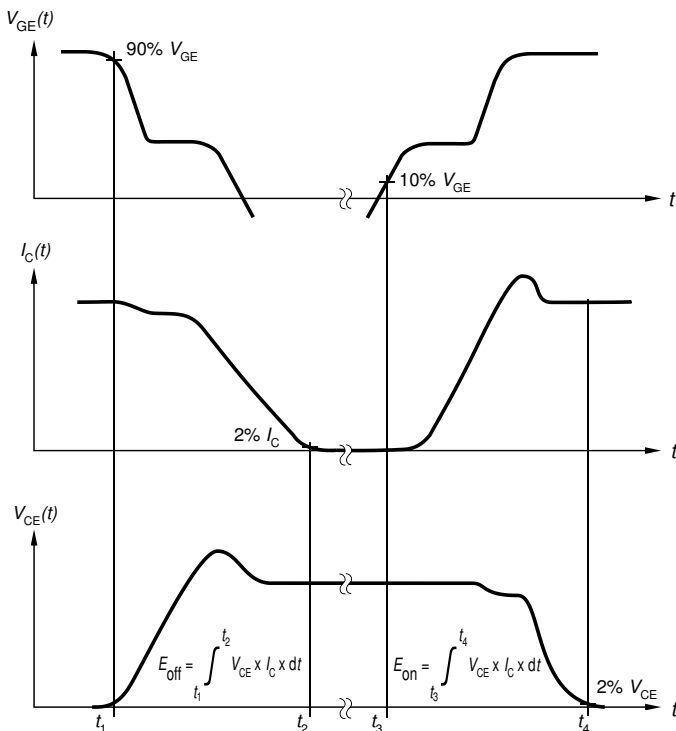


Figure B. Definition of switching losses

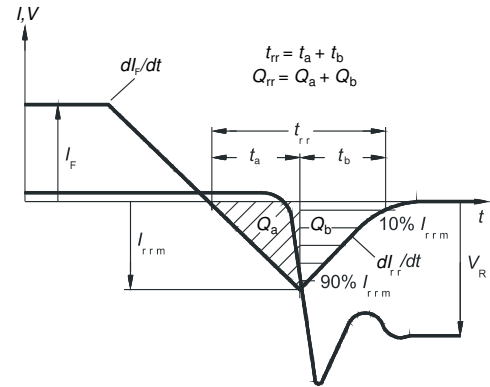


Figure C. Definition of diode switching characteristics

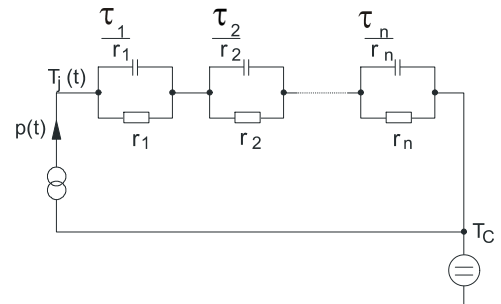


Figure D. Thermal equivalent circuit

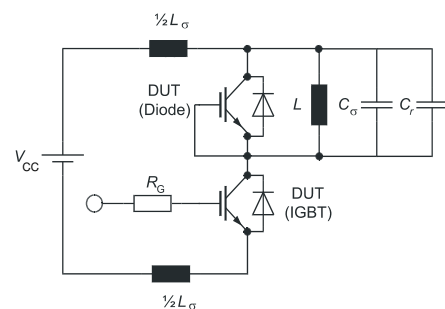


Figure E. Dynamic test circuit  
Parasitic inductance  $L_\sigma$ ,  
parasitic capacitor  $C_\sigma$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

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High speed switching series 5<sup>th</sup> generation

## Revision History

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IKB40N65ES5

**Revision: 2018-04-04, Rev. 2.1**

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Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2018-04-04	Final data sheet

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